

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of) MAIL STOP NEW APPLICATION
Hiroshi UEHARA et al.)
Application No.:) Group Art Unit:
Filed: October 20, 2004) Examiner:
For: THERMOPLASTIC RESIN) Confirmation No.:
COMPOSITION, POLYMER)
COMPOSITION, AND MOLDED)
PRODUCT COMPRISING THE)
COMPOSITION (as amended))

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to calculation of the filing fee, please amend the above-identified patent application as follows: